IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Type Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materi	ials and Mfg Information				
Supplie	r Information														
Company name* Compan				pany unique ID			Unique ID Authority					Response Date*			
nsemi												2024-04-19			
Contact N	Jame	Title - Contact]	Phone - Contact*				Email - Contact*					
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uthorize	ed Representative*	Title - Representative]	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	e Date Version Manufacturing Site		We	ight*	UOM	Unit Type		
		AR0330CM1C12SHK 3 MP 1/3 CIS A0-CP					2024-04-19			CP2			59	mg	Each
Ianufa	cturing Proccess Informa	tion													
	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD		-STD-020 MSL	Rating	Peak Process Body Temperature		ure Max Tim	ne at Peak	Temperature	Numb	er of Reflow Cyc	eles	
	SnAgCu		CU Alloy 5		5		260 C 3		30		seconds 3				
omments	3														
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applic											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	11.67	mg	Supplier	Silicon (Si)	7440-21-3		11.67	mg
Glass Attach Epoxy	0.01	mg	Supplier	Imidazole	288-32-4		0.0025	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.0075	mg
Glass Lid /Cap	40.57	mg	Supplier	Glass	65977-17-3		40.57	mg
Passivation	0.91	mg	Supplier	Pentaerythritol triacrylate	3524-68-3		0.1365	mg
			Supplier	2-(2-methoxypropoxy)propanol	34590-94-8		0.091	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.091	mg
			Supplier	9-Phenylacridine	602-56-2		0.0455	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.546	mg
RDL	0.61	mg	Supplier	Gold (Au)	7440-57-5		0.0061	mg
			Supplier	Copper (Cu)	7440-50-8		0.0305	mg
			Supplier	Aluminum (Al)	7429-90-5		0.5734	mg
Solder Ball	0.71	mg	Supplier	Silver (Ag)	7440-22-4		0.0471	mg
			Supplier	Tin (Sn)	7440-31-5		0.6313	mg
			Supplier	Copper (Cu)	7440-50-8		0.0315	mg
Solder Mask	4.11	mg	Supplier	Pentaaerythritol acrylate	4986-89-4		0.2466	mg
			Supplier	Pentaerythritol triacrylate	3524-68-3		0.2466	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.4932	mg
			Supplier	9-Phenylacridine	602-56-2		0.0822	mg
			Supplier	3-Methoxy-1-butanol	2517-43-3		1.3974	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.822	mg
			Supplier	1-Methoxy-2-propyl acetate (MPA)	108-65-6		0.822	mg